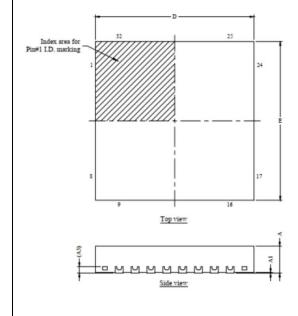


Sciosense Change Notification (CN)											
Originator:					No:	CN-2020-004					
Product(s) affected:	TDC-GI	TDC-GP22									
Change date:	End Q2' 2021, samples available end Q1' 21										
TYPE OF CHANGE											
DESCRIPTION AND JUSTIFICATION OF CHANGE NOTE (CN)											
- A new assembly lii improve the stand							efore				
Material to be changed		Before Change			After Change						
phy. Dimension A (over all height)		Min 0,80	Nom Max 0,85 0,90		Min 0,80	Nom 0,85	Max 0,90				
ВОМ											
Lead Frame Type:		Copper(Ag Ring)			Copper(Ag Ring)						
Lead Frame Core Material:		EFTEC64			EFTEC64T						
Ероху		8600			8200TI						
Bond Wire		1,0 mil Au			1,0 mil Au						
Mold Compound		(	G770HCD			G770HCD					
Lead Finish		Matte Tin			Matte Tin						
SUPPORTING DATA											

## Package dimensions:

Center pad side length E2 = 3.50mm (former 3.70mm)



	Package Dimension									
SYMBOL		Millimeter	r	Inches						
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX				
A	0.80	0.85	0.90	0.031	0.033	0.035				
Al	-	-	0.05	-	-	0.002				
A3		0.20 RE	F	0.008 REF						
b	0.20	0.25	0.30	0.008	0.010	0.012				
D	4.90	5.00	5.10	0.193	0.197	0.201				
D2	3.40	3.50	3.60	0.134	0.138	0.142				
E	4.90	5.00	5.10	0.193	0.197	0.201				
E2	3.40	3.50	3.60	0.134	0.138	0.142				
e		0.50 BSC		0.020 BSC						
el		3.50 BSC		0.138 BSC						
K	0.20	-	-	0.008	-	-				
L	0.30	0.40	0.50	0.012	0.016	0.020				

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The marking will now come without ams Logo. Top View:



GP22 Line 1: Fixed text

Line 2: Date code = YYWWR with YY= year code, WW= work week code, R Fixed Letter

## **CUSTOMER INFO & ACKNOWLEDGEMENT**

Please acknowledge receipt of this CN by replying to <a href="mailto:customersupport@sciosense.com">customersupport@sciosense.com</a> ScioSense is notifying you of this minor change and no further action is necessary from you.

Please forward any queries regarding this CN to customersupport@sciosense.com keeping your account manager in copy.